

## APPROVAL SHEET

MODEL NO:YXD050GQ40350

Approval option:  Specification

Sample

■ **Customer's Confirmation**

<b>Customer :</b>
<b>Approved by:</b>
<b>Date:</b>
<b>Note:</b>

■ **Center Confirmed:**

<b>Approved</b>	<b>Checked by</b>	<b>Made by</b>



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## 1. Introduction

### 1.1 Scope of application

This specification applies to the Negative type TFT transmissive dot matrix LCD module ,This LCD module should be designed for mobile phone use.

LCD specification: Dots 800xRGBx480.

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As to basic specification of the driver IC, refer to the IC (ILI5960+ILI6122) specification and datasheet.

### 1.2 Structure:

Double display structure:

TFT Module + FPC +BL

FULL 16.7M Color 5.0inch TFT LCD size for main LCD;

One bare chip with gold bump (COG) TECH;

24BIT RGB interface;

### 1.3 TFT features:

Structure: TFT PANNEL+IC+FPC+BL;

Transmissive Type LCD

800 dot-source and 480 dot-gate outputs;

White LED back light;

24BIT RGB interface;

### 1.4 Applications:

Mobile phone

PSP

PDA

GPS

Etc...

## 2. General specification

ITEM	Standard value	UNIT
LCD Type	TFT Transmissive	---
Driver element	a-Si TFT Active matrix	

Number of Dots	800*(RGB)*480	Dots
Pixel Arrangement	RGB Vertical Stripe	
Active Area	108 *64.8	mm
Viewing Direction	12 0' clock	
Driver IC	ILI5960+ILI6122	
Module Size (W*H*T)	120.7x75.8x2.8	mm
Approx. Weight	TBD	g
Back Light	White LED	
System interface	24 Bit RGB interface	
Backlight power consumption	768mW	

### 3. Mechanical drawing



Input voltage for logic	$V_{IN}$	-0.5	5.0	V
Supply current (One LED)	$I_{LED}$		40	mA
Operating temperature	$T_{OP}$	-20	+70	°C
Storage temperature	$T_{ST}$	-30	+80	°C

## 5. ELECTRICAL CHARACTERISTICS

### 5.1 Typical Operation Conditions

Item	Symbol	Min	Typ	Max	Unit	Applicable terminal
Supply voltage	$V_{dd}$	3.0	3.3	3.6	V	$V_{DD}$
Input voltage	$V_{IL}$	-0.3	-	$0.2 V_{dd}$	V	
	$V_{IH}$	$0.8 V_{dd}$	-	$V_{dd}$	V	
Input leakage current	$I_{LKG}$	-	-	-	$\mu A$	

### 5.2 Backlight Driving Conditions

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Voltage for LED backlight	$V_L$	-	19.2	-	V	Note 1
Current for LED backlight	$I_L$	-	40	-	mA	
LED life time	-	20,000	-	-	Hr	Note 2

Note 1: The LED Supply Voltage is defined by the number of LED at  $T_a=25^{\circ}C$  and  $I_L=40mA$ .

Note 2: The "LED life time" is defined as the module brightness decrease to 50% original brightness at  $T_a=25^{\circ}C$  and  $I_L=40mA$ . The LED lifetime could be decreased if operating  $I_L$  is larger than 50mA.

### 5.3. Timing Characteristics

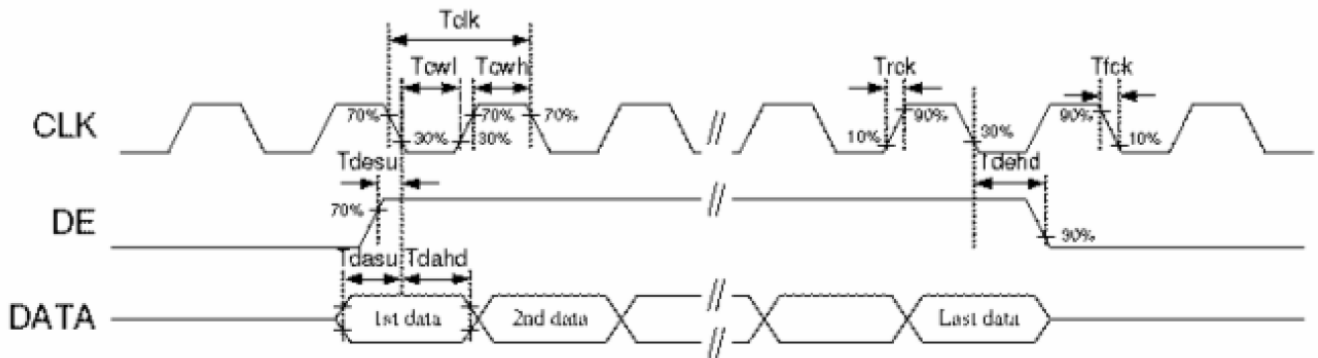
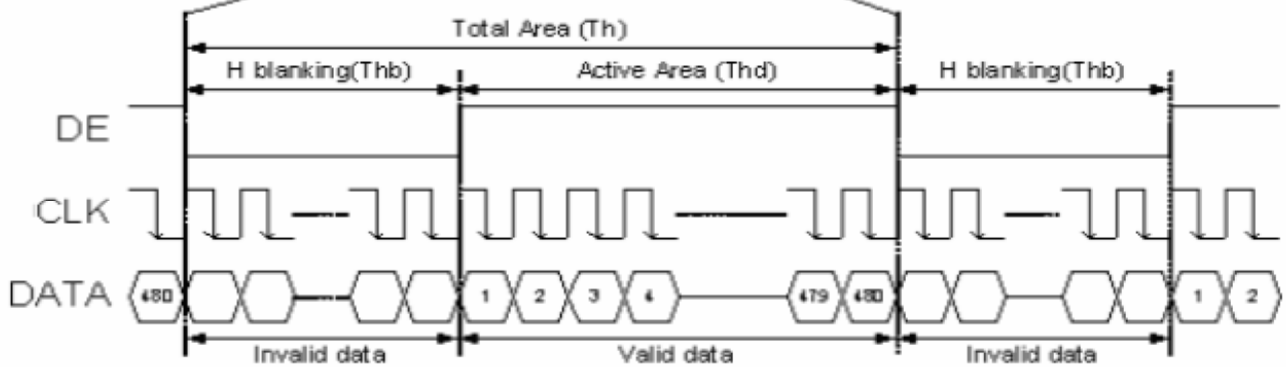
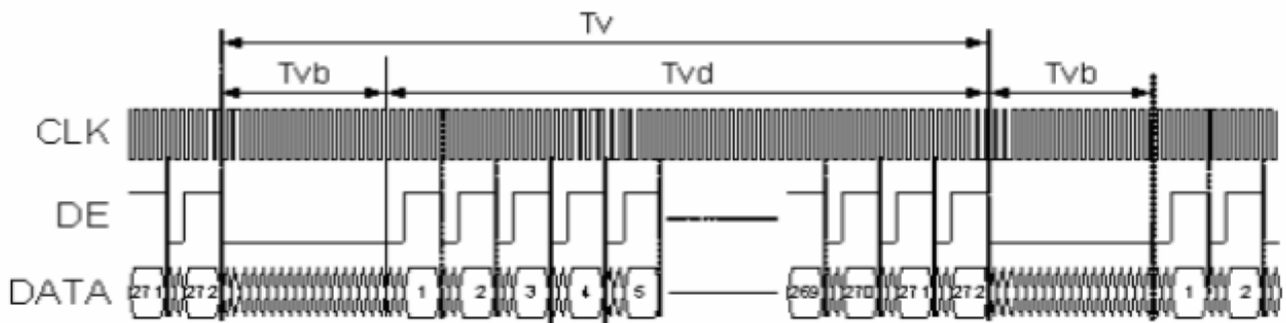
#### 5.3.1. Timing conditions

Parallel DE mode input timing table

Parameter	Symbol	Value			Unit
		Min.	Typ.	Max.	
CLK frequency	fclk	26.4	33.3	46.8	MHz
DEV period time	Tv	510	525	650	H
DEV display area	Tvd	480			H
DEV blanking	Tvb	30	45	170	H
DEH period time	Th	862	1056	1200	CLK
DEH display area	Thd	800			CLK
DEH blanking	Thb	62	256	400	CLK
CLK cycle time	Tclk	21.3	30	37.8	ns
Clock width of high level	Tcwh	40	50	60	%
Clock width of low level	Tcwl	40	50	60	%
Clock rising time	t <sub>rck</sub>	8	-	-	ns
Clock falling time	t <sub>fck</sub>	8	-	-	ns
Data Setup Time	t <sub>dasu</sub>	8	-	-	ns
Data Hold Time	t <sub>dahd</sub>	8	-	-	ns
DE Setup Time	t <sub>desu</sub>	8	-	-	ns
DE Hold Time	t <sub>dehd</sub>	8	-	-	ns

### 5.3.2. Timing diagram



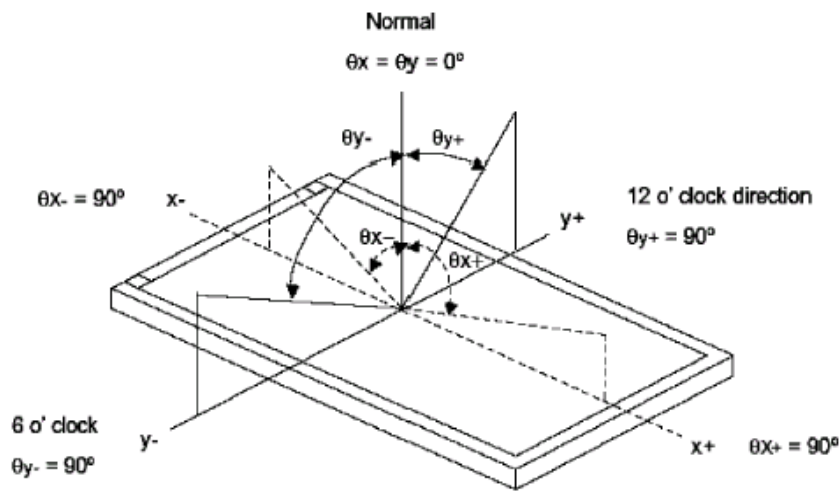


## 6. OPTICAL CHARACTERISTICS

ITEM	SYMBOL	CONDITIONS	SPECIFICATIONS			UNIT	NOTE
			MIN.	TYP.	MAX.		
Brightness	B	Viewing normal angle	300	350	--	$Cd/m^2$	All left side data are based on INNOLUX's product
Contrast Ratio	CR		-	500	--		
Response Time	$T_r+T_f$		--	20	--		
CIE	Red		Xr	0.540	0.590	0.640	

Color coordinate	Green	Y <sub>R</sub>		0.300	0.350	0.400	reference only
		X <sub>G</sub>		0.298	0.348	0.398	
		Y <sub>G</sub>		0.520	0.570	0.620	
	Blue	X <sub>B</sub>		0.095	0.145	0.195	
		Y <sub>B</sub>		0.060	0.110	0.160	
	White	X <sub>W</sub>		0.260	0.310	0.360	
Y <sub>W</sub>			0.280	0.330	0.380		
Viewing Angle	Hor.	$\theta_{x+}$	Center CR>=10	60	70	--	Deg.
		$\theta_{x-}$		60	70	--	
	Ver.	$\theta_{y+}$		40	50	--	
		$\theta_{y-}$		60	70		
Uniformity	Un			75	80		%

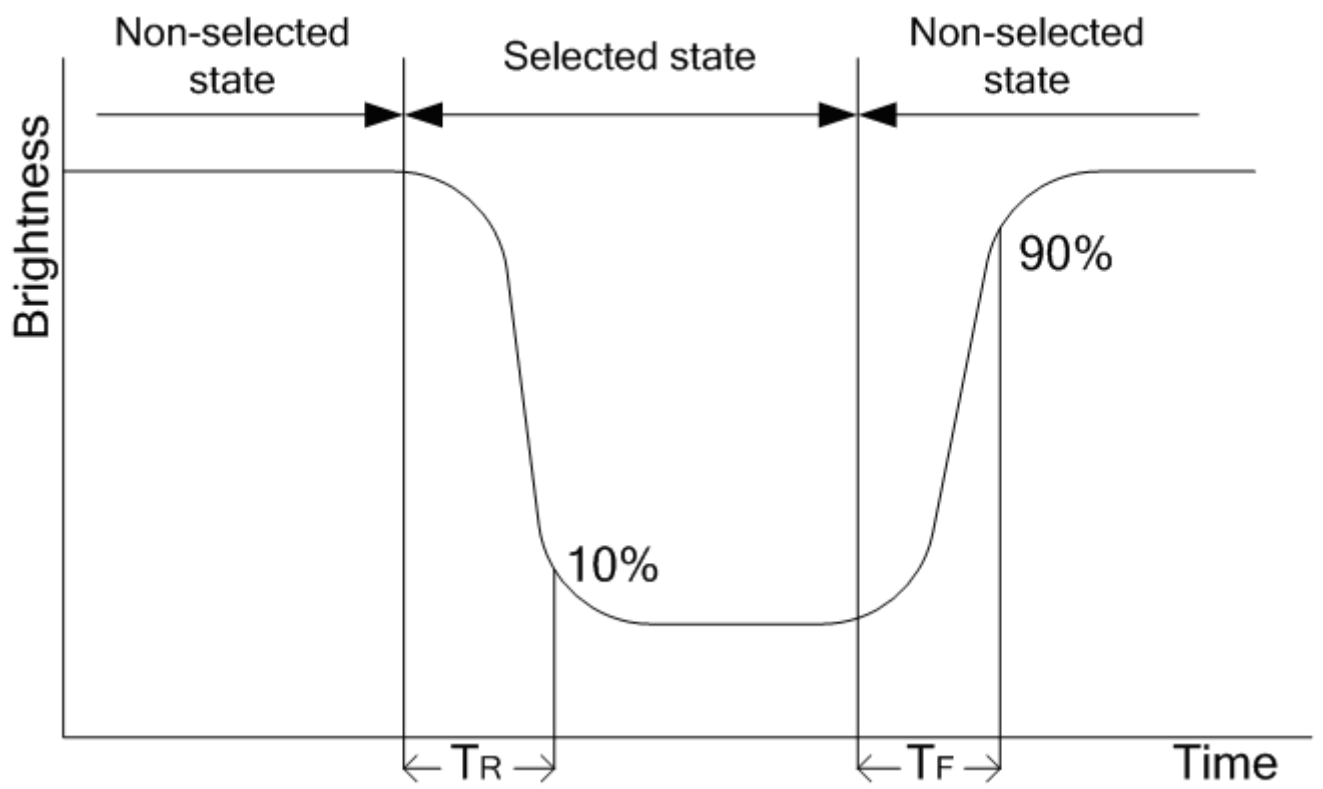
**Note 1 : Definition of Viewing Angle  $\theta_x$  and  $\theta_y$  :**



**Note 2: Definition of contrast ratio CR:**

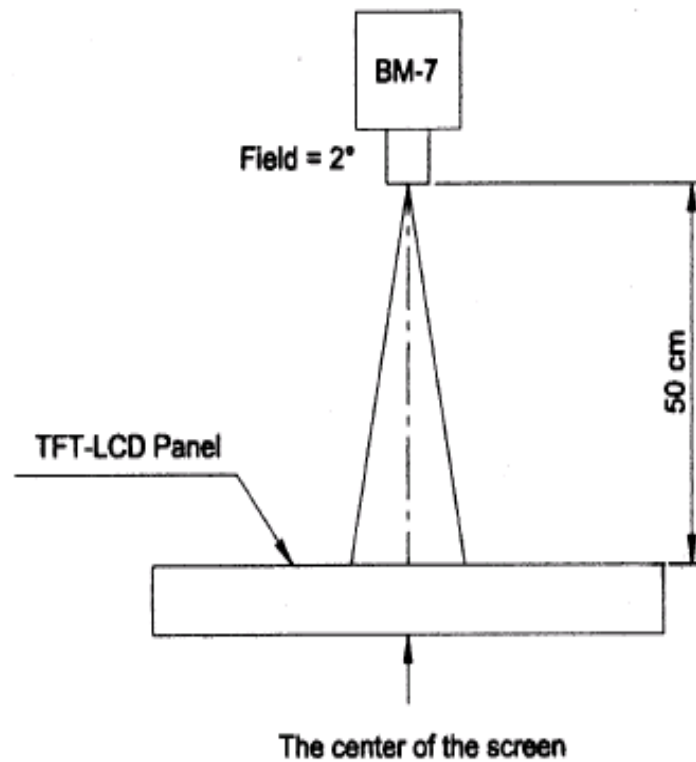
$$CR = \frac{\text{Brightness of non-selected dots (white)}}{\text{Brightness of selected dots (black)}}$$

**Note 3: Definition of response time ( $T_R$ ,  $T_F$ )**

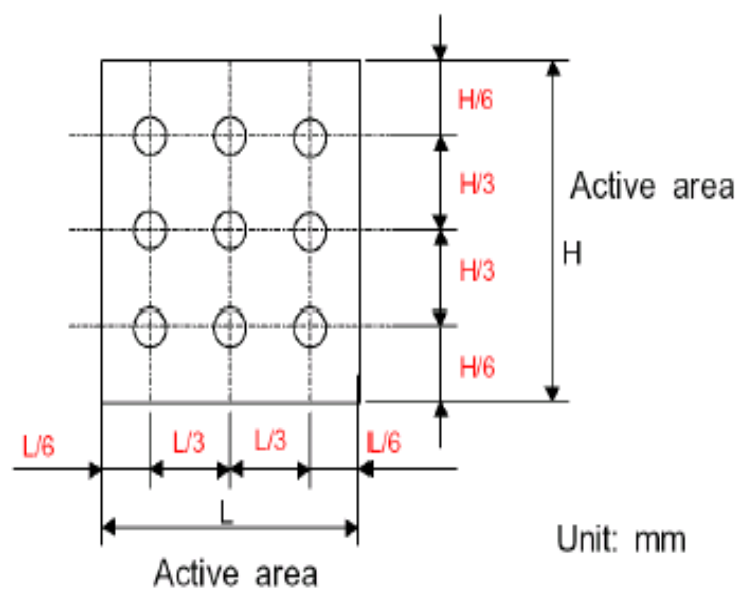


**The brightness test equipment setup**

20mA Field=2° (As measuring "black" image, field=2° is the best testing condition)



Note 4 :

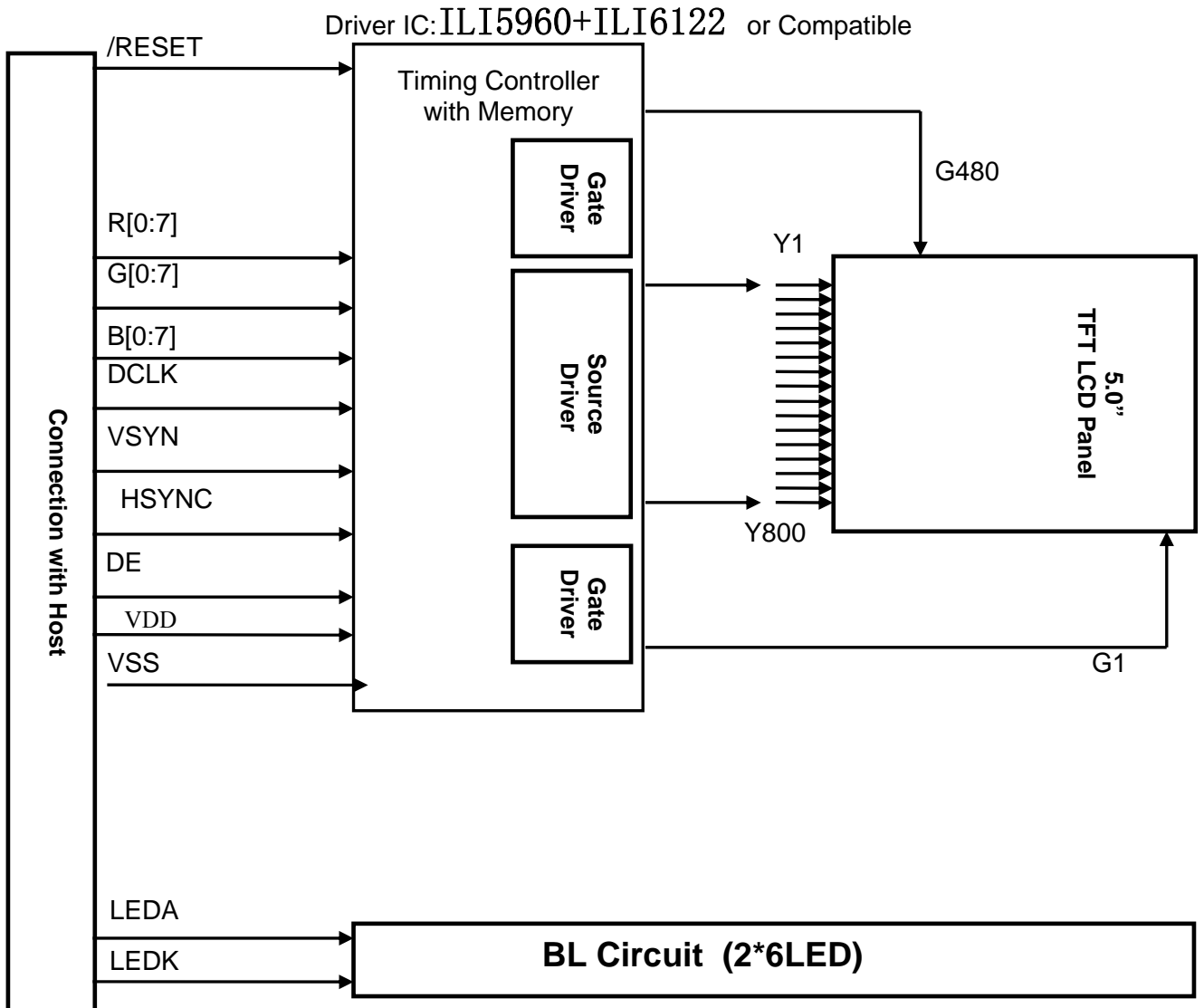


**7. Interface Pin Function**

Pin No	Symbol	Function
1	VLED-	BACK LIGHT POWER GROUND
2	VLED+	BACK LIGHT POWER SUPPLY
3	GND	POWER GROUND
4	VDD	POWER SUPPLY
5-12	R0-R7	RED DATA
13-20	G0-G7	GREEN DATA
21-28	B0-B7	BLUE DATA
29	GND	POWER GROUND
30	DCLK	In external interface mode, served as a dot clock signal.
31	DISP	Display control pin
32	HSYN	In external interface mode, served as a horizontal synchronized signal input
33	VSYNC	In external interface mode, served as a vertical synchronize signal input
34	DE	In external interface mode, polarity of ENABLE signal is synchronized with valid graphic data input.
35	NC	NC
36	GND	POWER GROUND
37	XR(NC)	TOUCH PANEL CONTROL PIN
38	YD(NC)	
39	XL(NC)	
40	YU(NC)	

NOTE:For digital RGB input data format, both SYNC mode and DE+SYNC mode are supported. If EN signal is fixed low. SYNC mode is used. Otherwise, DEN+SYNC is used

## 8. BLOCK DIAGRAM



## 9. Standard Specification for Reliability

### 9-1. Standard Specifications for Reliability of LCD Module

No	Item	Description
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01	High temperature operation	The sample should be allowed to stand at 70°C for 240 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
02	Low temperature operation	The sample should be allowed to stand at -20°C for 240 hours under driving condition and then returning it to normal temperature condition, and allowing it stand for 2 hours.
03	High temperature storage	The sample should be allowed to stand at 80°C for 240 hours under no-load condition, and then returning it to normal temperature condition, and allowing it stand for 2 hours.
04	Low temperature storage	The sample should be allowed to stand at -30°C for 240 hours under no-load condition, then returning it to normal temperature condition, and allowing it stand for 2 hours.
05	Moisture storage	The sample should be allowed to stand at 60°C,90%RH MAX for 240 hours under no-load condition, then taking it out and drying it at normal temperature for 2 hours.
06	Thermal shock storage	The sample should be allowed to stand the following 10 cycles : -30°C for 30 minutes → normal temperature for 5 minutes → +80°C for 30 minutes → normal temperature for 5 minutes, as one cycle.
07	Packing vibration	Frequency range : 10Hz ~ 55Hz Amplitude of vibration : 1.5mm Sweep time: 12 min X,Y,Z 2 hours for each direction.
08	Packing drop test	According to ASTM-D-5327.
09	Electrical Static Discharge	Air: ±4KV 150pF/330Ω 5 times
		Contact: ±2KV 150pF/330Ω 5 time

\*Sample size for each test item is 3~5pcs

## 9 - 2. Testing Conditions and Inspection Criteria

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in Table 12.2, Standard specifications for Reliability have been executed in order to ensure stability.

No	Item	Test Model	In section Criteria
01	Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
02	Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
03	Appearance	Visual inspection	Defect free.

9- 3. MTBF

MTBF	Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature (25±5°C), normal humidity (50±10% RH), and in area not exposed to direct sun light.
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## 10. Specification of Quality Assurance:

### 10-1. Purpose

This standard for Quality Assurance should affirm the quality of LCD module products to supply to purchaser by EASYTEK (Supplier).

### 10-2. Standard for Quality Test

#### a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

#### b. Electro-Optical Characteristics:

According to the individual specification to test the product.

#### c. Test of Appearance Characteristics:

According to the individual specification to test the product.

#### d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

#### e. Delivery Test:

Before delivering, the supplier should take the delivery test.

(i) Test method: According to MIL-STD105E.General Inspection Level II take a single time.

(ii) The defects classify of AQL as following:

Major defect: AQL = 0.65

Minor defect: AQL = 2.5

Total defects: AQL = 2.5

### 10-3. Non- conforming Analysis & Deal With Manners

#### a. Non- conforming Analysis:

(i) Purchaser should supply the detail data of non- conforming sample and the non- conforming.

(ii) After accepting the detail data from purchaser, the analysis of non- conforming should be finished in two weeks.

(iii) If supplier can not finish analysis on time, must announce purchaser before 3 days.

#### b. Disposition of non- conforming:

(i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.

(ii) Both supplier and customer should analyze the reason and discuss the disposition of non- conforming when the reason of nonconforming is not sure.

### 10-4. Agreement items

Both sides should discuss together when the following problems happen.

a. There is any problem of standard of quality assurance, and both sides should think that must be modified.

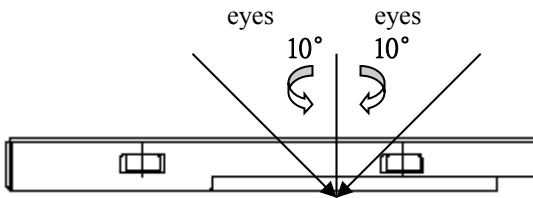
b. There is any argument item which does not record in the standard of quality assurance.

c. Any other special problem.

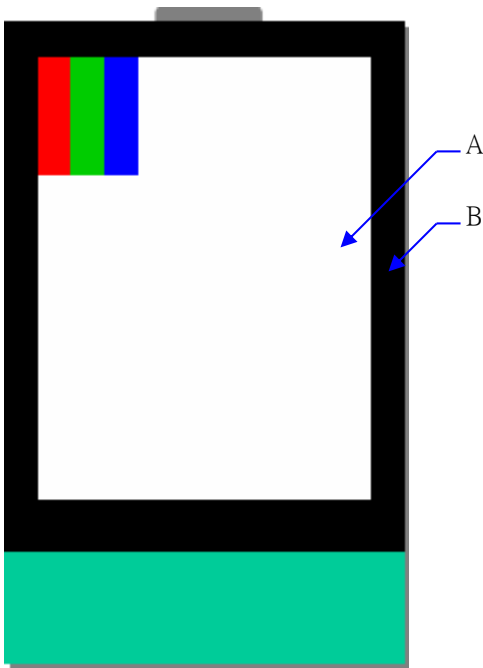
10-5. Standard of The Product Appearance Test

a. Manner of appearance test:

- (i) The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must be at 30±5cm.
- (ii) When test the model of transmissive product must add the reflective plate.
- (iii) The test direction is base on around 10° of vertical line.
- (iii) Temperature: 25±5°C Humidity: 60±10%RH



(iv) Definition of area:



A. Area: Viewing area.

B. Area: Out of viewing area.

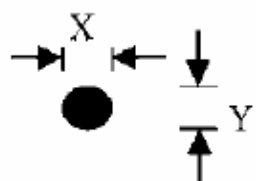
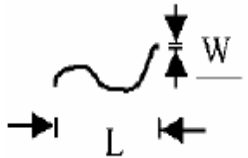
(Outside viewing area)

b. Basic principle:

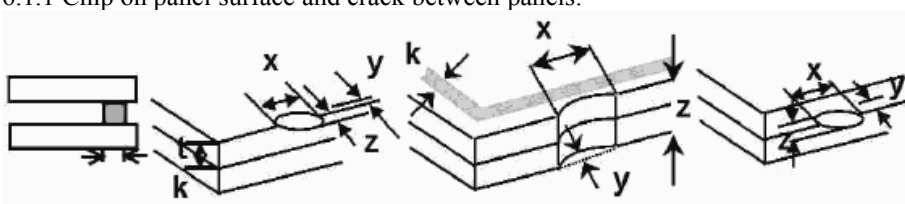
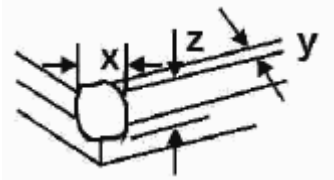
- (i) It will accord to the AQL when the standard can not be described.
- (ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.
- (iii) Must add new item on time when it is necessary.

c. Standard of inspection: (Unit: mm)

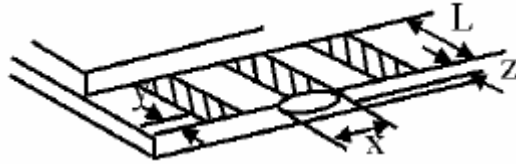
10-6. Inspection specification

NO	Item	Criterion	AQL												
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 LCD viewing angle defect. 1.7 Mixed product types. 1.8 Flicker	<b>0.65</b>												
02	Black or White spots or Bright spots or Color spots on LCD (Display only)	2.1 White and black or color spots on display $\leq 0.25\text{mm}$ , no more than Five spots. 2.2 Densely spaced: No more than three spots within 3mm.	<b>2.5</b>												
03	LCD and Touch Panel black spots, white spots, contamination (non – display)	3.1 Round type: As following drawing $\Phi = (X+Y) / 2$  <table border="1" data-bbox="813 896 1348 1108"> <thead> <tr> <th>Size(mm)</th> <th>Acceptable Q'ty</th> </tr> </thead> <tbody> <tr> <td><math>\Phi \leq 0.10</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>0.10 &lt; \Phi \leq 0.20</math></td> <td>2</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.25</math></td> <td>2</td> </tr> <tr> <td><math>0.25 &lt; \Phi \leq 0.30</math></td> <td>1</td> </tr> <tr> <td><math>0.30 &lt; \Phi</math></td> <td>0</td> </tr> </tbody> </table> <p style="text-align: right;">* Densely spaced: No more than two spots within 3mm.</p>	Size(mm)	Acceptable Q'ty	$\Phi \leq 0.10$	Accept no dense	$0.10 < \Phi \leq 0.20$	2	$0.20 < \Phi \leq 0.25$	2	$0.25 < \Phi \leq 0.30$	1	$0.30 < \Phi$	0	<b>2.5</b>
		Size(mm)	Acceptable Q'ty												
$\Phi \leq 0.10$	Accept no dense														
$0.10 < \Phi \leq 0.20$	2														
$0.20 < \Phi \leq 0.25$	2														
$0.25 < \Phi \leq 0.30$	1														
$0.30 < \Phi$	0														
3.2 Line type: (As following drawing)  <table border="1" data-bbox="718 1220 1348 1422"> <thead> <tr> <th>Length(m m)</th> <th>Width(mm)</th> <th>Acceptable Q'ty</th> </tr> </thead> <tbody> <tr> <td>---</td> <td><math>W \leq 0.02</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>L \leq 3.0</math></td> <td><math>0.02 &lt; W \leq 0.05</math></td> <td rowspan="2">2</td> </tr> <tr> <td><math>L \leq 2.5</math></td> <td><math>0.03 &lt; W \leq 0.08</math></td> </tr> <tr> <td>---</td> <td><math>0.08 &lt; W</math></td> <td>Rejection</td> </tr> </tbody> </table> <p style="text-align: right;">* Densely spaced: No more than two lines within 3mm.</p>	Length(m m)	Width(mm)	Acceptable Q'ty	---	$W \leq 0.02$	Accept no dense	$L \leq 3.0$	$0.02 < W \leq 0.05$	2	$L \leq 2.5$	$0.03 < W \leq 0.08$	---	$0.08 < W$	Rejection	<b>2.5</b>
Length(m m)	Width(mm)	Acceptable Q'ty													
---	$W \leq 0.02$	Accept no dense													
$L \leq 3.0$	$0.02 < W \leq 0.05$	2													
$L \leq 2.5$	$0.03 < W \leq 0.08$														
---	$0.08 < W$	Rejection													

NO	Item	Criterion	AQL
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04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction	<table border="1"> <tr> <th>Size <math>\Phi</math>(mm)</th> <th>Acceptable Q'ty</th> </tr> <tr> <td><math>\Phi \leq 0.20</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.50</math></td> <td>3</td> </tr> <tr> <td><math>0.50 &lt; \Phi \leq 1.00</math></td> <td>2</td> </tr> <tr> <td><math>1.00 &lt; \Phi</math></td> <td>0</td> </tr> <tr> <td>Total Q'ty</td> <td>3</td> </tr> </table>	Size $\Phi$ (mm)	Acceptable Q'ty	$\Phi \leq 0.20$	Accept no dense	$0.20 < \Phi \leq 0.50$	3	$0.50 < \Phi \leq 1.00$	2	$1.00 < \Phi$	0	Total Q'ty	3	2.5					
Size $\Phi$ (mm)	Acceptable Q'ty																				
$\Phi \leq 0.20$	Accept no dense																				
$0.20 < \Phi \leq 0.50$	3																				
$0.50 < \Phi \leq 1.00$	2																				
$1.00 < \Phi$	0																				
Total Q'ty	3																				
05	Scratches	Follow NO.3 -2 Line Type.																			
06	Chipped glass	<p>Symbols:  x: Chip length y: Chip width z: Chip thickness  k: Seal width t: Glass thickness a: LCD side length  L: Electrode pad length</p> <p>6.1 General glass chip:  6.1.1 Chip on panel surface and crack between panels:</p>  <table border="1" data-bbox="383 873 1197 985"> <tr> <td>z: Chip thickness</td> <td>y: Chip width</td> <td>x: Chip length</td> </tr> <tr> <td><math>Z \leq 1/2t</math></td> <td>Not over viewing area</td> <td><math>x \leq 1/8a</math></td> </tr> <tr> <td><math>1/2t &lt; z \leq 2t</math></td> <td>Not exceed 1/3k</td> <td><math>x \leq 1/8a</math></td> </tr> </table> <p style="text-align: right;">⊙ Unit:</p> <p>mm  ⊙ If there are 2 or more chips, x is the total length of each chip</p> <p>6.1.2 Corner crack:</p>  <table border="1" data-bbox="383 1344 1197 1456"> <tr> <td>z: Chip thickness</td> <td>y: Chip width</td> <td>x: Chip length</td> </tr> <tr> <td><math>Z \leq 1/2t</math></td> <td>Not over viewing area</td> <td><math>x \leq 1/8a</math></td> </tr> <tr> <td><math>1/2t &lt; z \leq 2t</math></td> <td>Not exceed 1/3k</td> <td><math>x \leq 1/8a</math></td> </tr> </table> <p style="text-align: right;">⊙ Unit:</p> <p>mm  ⊙ If there are 2 or more chips, x is the total length of each chip</p>	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$	2.5
z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
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z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
$1/2t < z \leq 2t$	Not exceed 1/3k	$x \leq 1/8a$																			

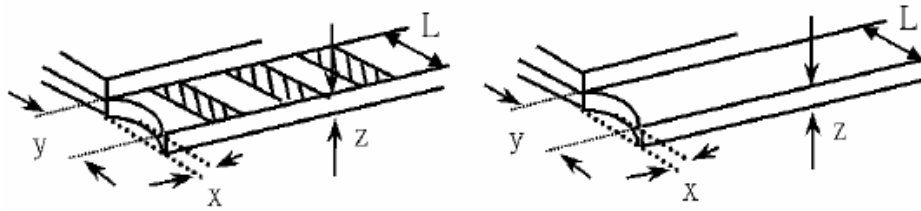
NO	Item	Criterion	AQL
07	Glass crack	<p>Symbols:  x: Chip length y: Chip width z: Chip thickness  k: Seal width t: Glass thickness a: LCD side length  L: Electrode pad length</p> <p>7.2 Protrusion over terminal:  7.2.1 Chip on electrode pad:</p>	2.5



y: Chip width	x: Chip length	z: Chip thickness
$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$

7.2.2  
conductive portion:

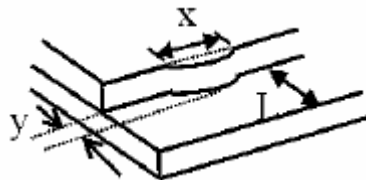
Non-



y: Chip width	x: Chip length	z: Chip thickness
$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$

- ⊙ If there chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.
- ⊙ If the product will be heat sealed by the customer, the alignment mark must not be damaged.

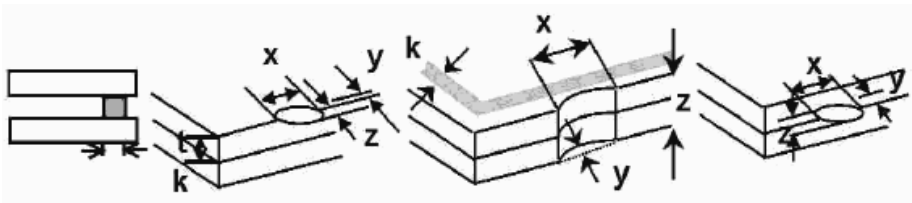
7.2.3 Substrate protuberance and internal crack

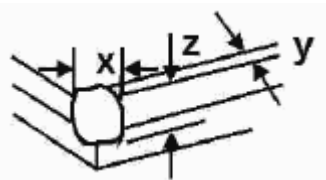


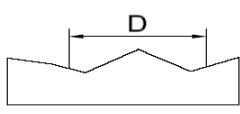
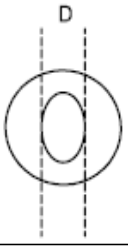
y: width	x: length
$y \leq 1/3L$	$X \leq a$

NO	Item	Criterion	AQL
08	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
09	Backlight elements	9.1 Illumination source flickers when lit. 9.2 Spots or scratches that appear when lit must be judged. Using LCD spot, lines and contamination standards. 9.3 Backlight doesn't light or color is wrong.	2.5 2.5 0.65

10	Bezel	Bezel must comply with product specifications.	2.5
11	PCB、COB	<p>11.1 COB seal may not have pinholes larger than 0.2mm or contamination.</p> <p>11.2 COB seal surface may not have pinholes through to the IC.</p> <p>11.3 The height of the COB should not exceed the height indicated in the assembly diagram.</p> <p>11.4 There may not be more than 2mm of sealant outside the seal area on PCB. And there should be no more than three places.</p> <p>11.5 Parts on PCB must be the same as on the production characteristic chart, There should be no wrong parts, missing parts or excess parts.</p> <p>11.6 The jumper on the PCB should conform to the product characteristic chart.</p>	<p>2.5</p> <p>2.5</p> <p>2.5</p> <p>2.5</p> <p>0.65</p> <p>0.65</p>
12	FPC	<p>12.1 FPC terminal damage <math>\leq 1/2</math> FPC terminal width and can not affect the function , we judge accept.</p> <p>12.2 FPC alignment hole damage <math>\leq 1/2</math> alignment area and can not affect the function , we judge accept.</p>	<p>2.5</p> <p>2.5</p>
13	Soldering	<p>13.1 No cold solder joints, missing solder connections, oxidation or icicle.</p> <p>13.2 No short circuits in components on PCB or FPC.</p>	<p>2.5</p> <p>0.65</p>

NO	Item	Criterion	AQL
14	Touch Panel Chipped glass	<p>Symbols:  x: Chip length    y: Chip width    z: Chip thickness  k: Seal width    t: Touch Panel Total thickness    a: LCD side length  L: Electrode pad length</p> <p>14.1 General glass chip:  14.1.1 Chip on panel surface and crack between panels:</p> 	2.5

z: Chip thickness	y: Chip width	x: Chip length	⊙ Unit: mm ⊙ If
there are 2 or more chips, x is the total length of each chip 14.1.2 Corner crack:			
			
z: Chip thickness	y: Chip width	x: Chip length	⊙ Unit: mm ⊙ If
there are 2 or more chips, x is the total length of each chip			

NO	Item	Criterion	AQL										
15	Touch Panel(Fish eye, dent and bubble on film)	<table border="1"> <thead> <tr> <th>SIZE(mm)</th> <th>Acceptable Q'ty</th> </tr> </thead> <tbody> <tr> <td><math>\Phi \leq 0.2</math></td> <td>Accept no dense</td> </tr> <tr> <td><math>0.2 &lt; D \leq 0.4</math></td> <td>5</td> </tr> <tr> <td><math>0.4 &lt; D \leq 0.5</math></td> <td>2</td> </tr> <tr> <td><math>0.5 &lt; D</math></td> <td>0</td> </tr> </tbody> </table>  	SIZE(mm)	Acceptable Q'ty	$\Phi \leq 0.2$	Accept no dense	$0.2 < D \leq 0.4$	5	$0.4 < D \leq 0.5$	2	$0.5 < D$	0	2.5
SIZE(mm)	Acceptable Q'ty												
$\Phi \leq 0.2$	Accept no dense												
$0.2 < D \leq 0.4$	5												
$0.4 < D \leq 0.5$	2												
$0.5 < D$	0												
16	Touch Panel Newton ring	Newton ring dimension $\leq 1/2$ touch panel area and not affect font and line distortion( $\leq 2.5\%$ ), it is acceptable.	2.5										
17	Touch Panel Linearity	Less than 2.5% is acceptable.	2.5										

18	LCD Ripple	Touch the touch panel , can not see the LCD ripple. Pen: R 1.0mm silicon rubber. Operation Force: 80g	2.5
19	General appearance	19.1 Pin type must match type in specification sheet. 19.2 LCD pin loose or missing pins. 19.3 Product packaging must the same as specified on packaging specification sheet. 19.4 Product dimension and structure must conform to product specification sheet.	0.65 0.65 0.65 0.65

## 11. Packing method

--TBD